

Empanelment of vendors for E-signature Services and E Stamping (Stamp Duty)

RFP NO. BFSL / CCI RFP/2020-21/02.

RFP Dated: 05th Dec, 2020.

Addendum 02, Dated 28th Dec, 2020.

- **Extension for BID submission and opening of eligibility & technical bid is proposed as under.**

Kindly refer below details:

Last date & time for submission of Bids	04-01-2021 at 03.00 pm
Date and time of Opening of Eligibility and Technical Bid	04-01-2021 at 03.30 pm